Part Number : 787885024
Product Description : Milli-Grid Receptacle, Surface Mount, Vertical, Top Entry, without Plastic Pegs, without Cap, Tube, 2.50µm Tin (Sn), 50 Circuits, Lead-Free
Series Number : 78788
Status : Active
Product Category : PCB Headers and Receptacles



Documents and Resources

Drawings

787885024_sd.pdf

PK-78788-004-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

503940001-AS-000.pdf

PS-78788-001-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 33; 44
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2024)6225-DC (07 Nov 2024)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	78788
Description	Milli-Grid Receptacle, Surface Mount, Vertical, Top Entry, without Plastic Pegs, without Cap, Tube, 2.50µm Tin (Sn), 50 Circuits, Lead-Free
Application	Board-to-Board, Signal
Component Type	PCB Receptacle
Product Name	Milli-Grid
UPC	889056046206

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	1.0A
Voltage - Maximum	125V AC (RMS)/DC

Physical

Circuits (Loaded)	50
Circuits (maximum)	50
Color - Resin	Black
Durability (mating cycles max)	30
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Lock to Mating Part	None
Material - Metal	Copper Alloy
Material - Plating Mating	Tin
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	1.412/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tube
PCB Locator	No
PCB Retention	None
Pitch - Mating Interface	2.00mm
Plating min - Mating	2.500µm
Plating min - Termination	2.500µm
Polarized to Mating Part	No
Polarized to PCB	No
Robotic Placement	None
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Surface Mount

Solder Process Data

Max-Duration	10
Lead-Free Process Capability	REFLOW
Max-Cycle	1
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
Milli-Grid Vertical Through Hole Headers	87758
Milli-Grid Vertical Surface Mount Headers	87759
Milli-Grid Right-Angle Through Hole Headers	87760
Milli-Grid Vertical, Dual Row, Through Hole Headers	87831
Milli-Grid Vertical, Dual Row, Surface Mount Headers	87832
Milli-Grid Right-Angle Dual Row Through Hole Headers	87833
Milli-Grid Vertical, Dual Row, Through Hole Headers	151117
Milli-Grid Vertical, Dual Row, Surface Mount Headers	151118
Milli-Grid Right-Angle, Dual Row, Through Hole Headers	151119
Milli-Grid Right-Angle, Dual Row, Surface Mount Headers	151120